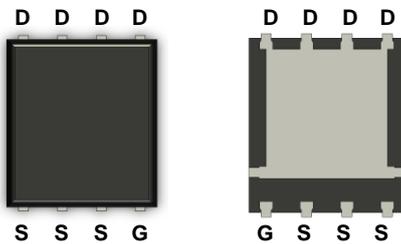


General Description

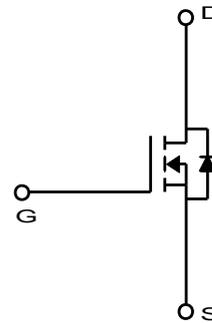
The MDU1511 uses advanced MagnaChip's MOSFET Technology, which provides high performance in on-state resistance, fast switching performance and excellent quality. MDU1511 is suitable device for DC/DC Converter and general purpose applications.

Features

- $V_{DS} = 30V$
- $I_D = 100A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} < 2.4 m\Omega$ @ $V_{GS} = 10V$
- $R_{DS(ON)} < 3.3 m\Omega$ @ $V_{GS} = 4.5V$
- 100% UIL Tested
- 100% Rg Tested



PowerDFN56



Absolute Maximum Ratings ($T_a = 25^\circ C$)

Characteristics		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	30	V
Gate-Source Voltage		V_{GSS}	± 20	V
Continuous Drain Current ⁽¹⁾	$T_C = 25^\circ C$	I_D	100.0	A
	$T_C = 70^\circ C$		94.0	
	$T_A = 25^\circ C$		36.1 ⁽³⁾	
	$T_A = 70^\circ C$		28.8 ⁽³⁾	
Pulsed Drain Current		I_{DM}	400	A
Power Dissipation	$T_C = 25^\circ C$	P_D	78.1	W
	$T_C = 70^\circ C$		50.0	
	$T_A = 25^\circ C$		5.5 ⁽³⁾	
	$T_A = 70^\circ C$		3.5 ⁽³⁾	
Single Pulse Avalanche Energy ⁽²⁾		E_{AS}	287	mJ
Junction and Storage Temperature Range		T_J, T_{stg}	-55~150	$^\circ C$

Thermal Characteristics

Characteristics		Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	Steady State	$R_{\theta JA}$	22.7	$^\circ C/W$
Thermal Resistance, Junction-to-Case	Steady State	$R_{\theta JC}$	1.6	

Ordering Information

Part Number	Temp. Range	Package	Packing	Quantity	RoHS Status
MDU1511RH	-55~150°C	PowerDFN56	Tape & Reel	3000 units	Halogen Free

Electrical Characteristics (T_J = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V	30	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.3	1.8	2.7	
Drain Cut-Off Current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V	-	-	1	μA
		T _J =55°C	-	-	5	
Gate Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V	-	-	±0.1	
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 28A	-	2.0	2.4	mΩ
		T _J =125°C	-	2.9	3.5	
		V _{GS} = 4.5V, I _D = 24A	-	2.7	3.3	
Forward Transconductance	g _{fs}	V _{DS} = 5V, I _D = 10A	-	45	-	S
Dynamic Characteristics						
Total Gate Charge	Q _{g(10V)}	V _{DS} = 15V, I _D = 28A, V _{GS} = 10V	38.8	51.8	64.8	nC
Total Gate Charge	Q _{g(4.5V)}		18.7	25.0	31.3	
Gate-Source Charge	Q _{gs}		-	9.9	-	
Gate-Drain Charge	Q _{gd}		-	9.4	-	
Input Capacitance	C _{iss}	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	2510	3347	4184	pF
Reverse Transfer Capacitance	C _{rss}		246	328	410	
Output Capacitance	C _{oss}		490	653	817	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DS} = 15V, I _D = 28A, R _G = 3.0Ω	-	11.2	-	ns
Rise Time	t _r		-	23.2	-	
Turn-Off Delay Time	t _{d(off)}		-	45.6	-	
Fall Time	t _f		-	18.6	-	
Gate Resistance	R _g	f=1 MHz	-	1.0	2.0	Ω
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 28A, V _{GS} = 0V	-	0.8	1.1	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 28A, di/dt = 100A/μs	-	33.8	50.7	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	22.3	33.5	nC

Note :

- Surface mounted FR-4 board by JEDEC (jesd51-7)
- E_{AS} is tested at starting T_J = 25°C, L = 0.1mH, I_{AS} = 42.0A, V_{DD} = 27V, V_{GS} = 10V
- T < 10sec.

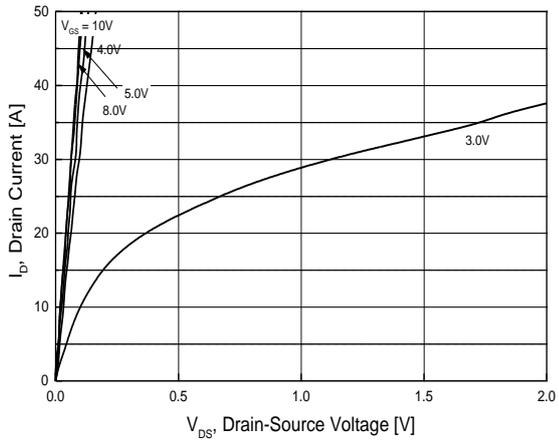


Fig.1 On-Region Characteristics

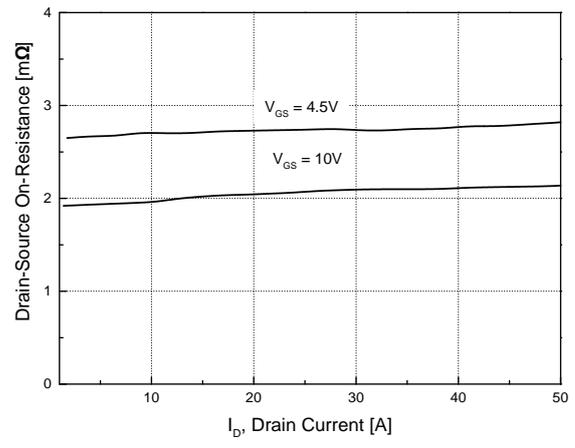


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

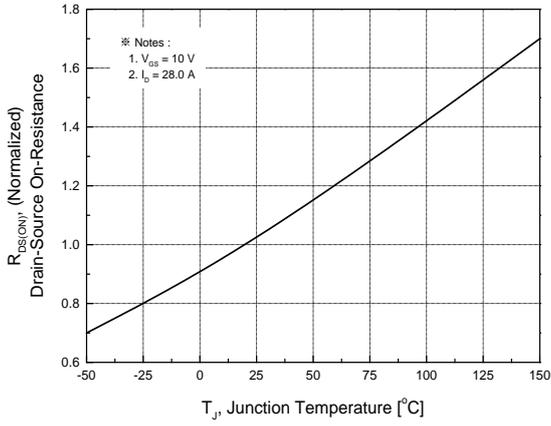


Fig.3 On-Resistance Variation with Temperature

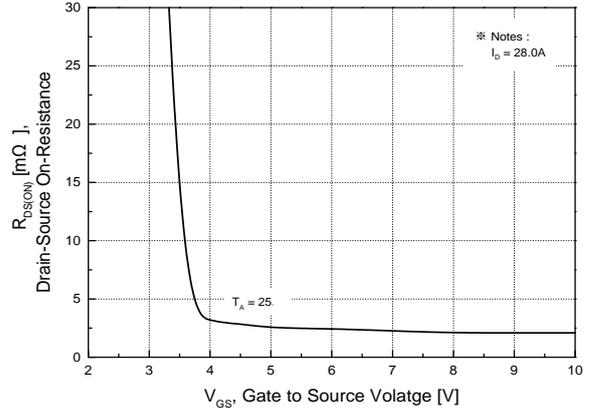


Fig.4 On-Resistance Variation with Gate to Source Voltage

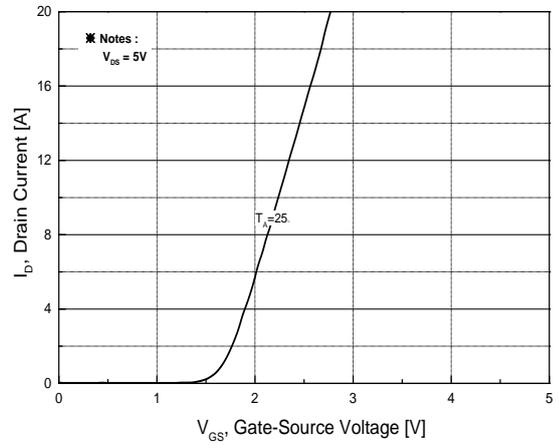


Fig.5 Transfer Characteristics

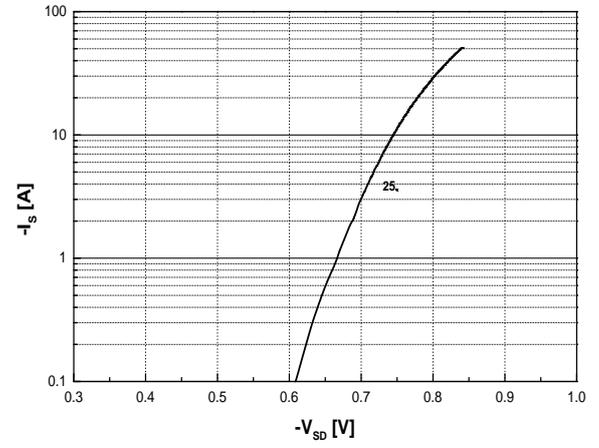


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

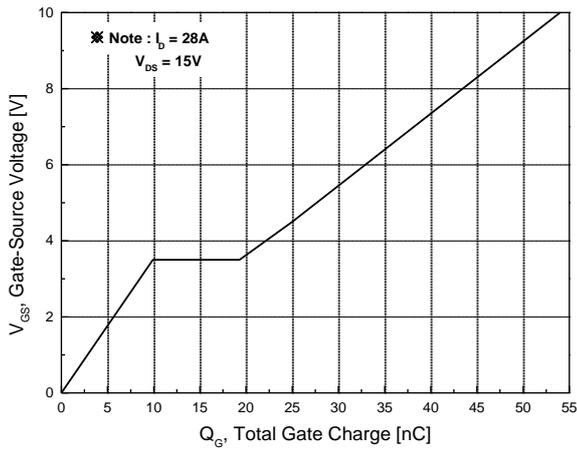


Fig.7 Gate Charge Characteristics

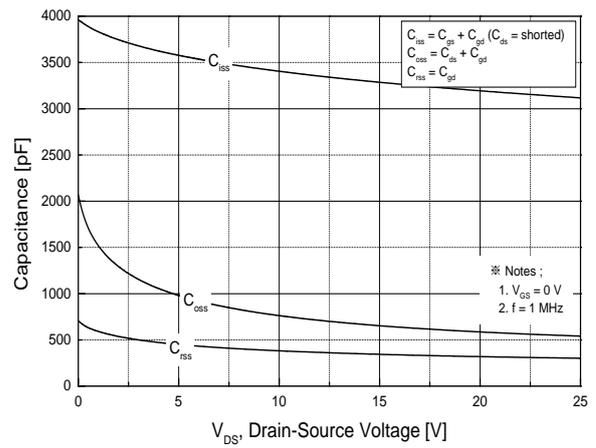


Fig.8 Capacitance Characteristics

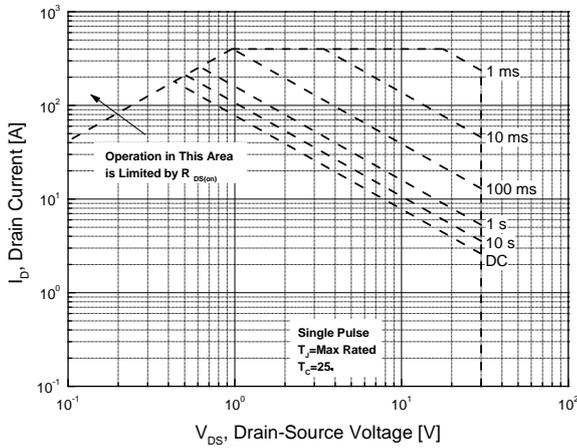


Fig.9 Maximum Safe Operating Area

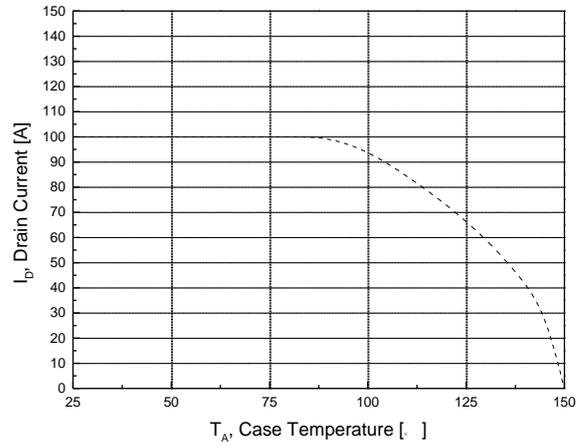


Fig.10 Maximum Drain Current Vs. Case Temperature

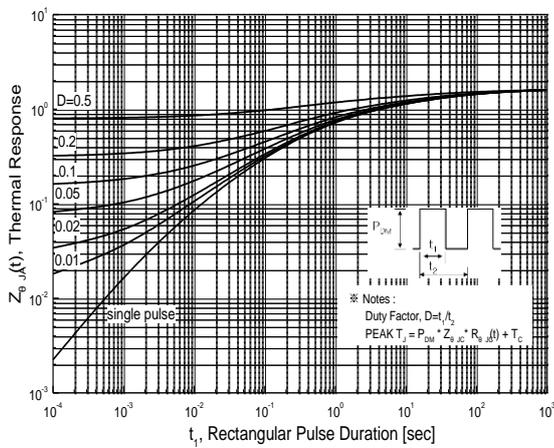
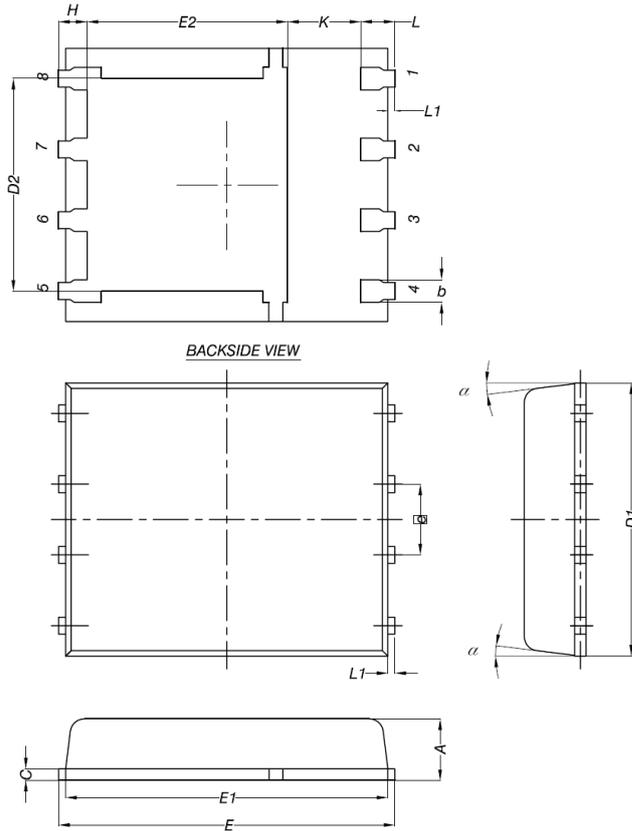


Fig.11 Transient Thermal Response Curve

Package Dimension

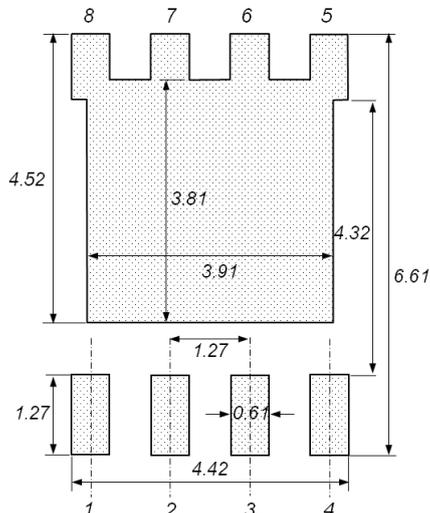
PowerDFN56 (5x6mm)

Dimensions are in millimeters, unless otherwise specified



Dimension	MILLIMETERS	
	Min	Max
A	0.90	1.10
b	0.33	0.51
C	0.20	0.34
D1	4.50	5.10
D2	-	4.22
E	5.90	6.30
E1	5.50	6.10
E2	-	4.30
e	1.27BSC	
H	0.41	0.71
K	0.20	-
L	0.51	0.71
α	0°	12°

Land Pattern



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